

Quarterly Reliability Monitoring Results

Quarters: Q3/2021 to Q4/2022

Based on structural similarity

Supplier Nexperia B.V. Name of Laboratory Assembly reliability labs Based on AEC-Q101 Test		User Part Number PZU36B Part Description										
									Nexperia DHAM			
									SMD package			
		Test Conditions	Duration	# Lots	# Quantity	# Rejects						
			TEST									
			Pre- and Post-Stress									
# E1	Electrical Test	Tamb = 25 °C	N/A	see below	all parts	see below						
İ		JESD22-A113										
		Bake Tamb = 125 °C	24 hours									
	PC	Soak Tamb = 85 °C, RH = 85%	168 hours			_						
# A1	Preconditioning	Reflow soldering	3 cycles	1168	66640	0						
		MIL-STD-750-1										
	HTRB	M1038 Method A										
# D1		Tj = Tjmax, VR = 80 % of rated reverse	1000	100	11000	0						
# B1	Bias	voltage	1000 hours	198	11960	0						
		MIL-STD-750-1										
	SSOP	M1038 Method B										
# B1b	Steady State Operational	Tj = Tjmax, Iz = 100% of max. datasheet reverse current	1000 haves	24	1760	0						
# 610	Steady State Operational	reverse current	1000 hours	24	1760	U						
	тс	JESD22-A104										
# A4	Temperature Cycling	-65 °C to Timax, not to exceed 150°C	1000 cycles	240	14800	0						
# A4	remperature cycling	os e to rimax, not to exceed 150 e	1000 Cycles	240	14600	U						
	UHAST	JESD22-A118										
# A3 or	Unbiased HAST	Tamb = 130 °C, RH = 85 %										
" 7.5 C.	Official Control	JESD22-A102	- 96 hours	240	14800	0						
	AC	Tamb = 121 °C, RH = 100 %										
# A3 alt	Autoclave	Pressure = 205 kPa (29.7 psia)										
# A3 aic	7.000.010	ressure Les in a (LST) pola										
	H3TRB	JESD22-A101										
	High Humidity High	Tamb = 85 °C, RH = 85%, VR = 80 % of										
# A2 alt	Temperature Reverse Bias		1000 hours	240	14800	0						
" 712 die	,	MIL-STD-750 Method 1037	_500		000	-						
	IOL	ton = toff, devices powered to insure ΔTj =										
# A5	Intermittent Operating Life		1000 hours	264	16720	0						
		,				-						
	RSH	JESD22-A111										
# C8	Resistance to Solder Heat		10 s	184	5520	0						
50	SD					-						
# C10	Solderability	J-STD-002		501	5010	0						

^[1] The maximum applied voltage is limited by test chamber set up and does not exceed 115V.

Calculation of FIT and MTTF

Test considered for FIT calculation: High Temperature Reverse Bias (HTRB, Test #B1) Confidence level 60%, derated to 55 °C, activation energy 0.7 eV, test time 168 to 1000 hours

Wafer Fab	Technology	Quantity	Rejects	Failure Rate (FIT)	MTTF (hrs)
Nexperia					
DHAM	Zener	11960	0	0,36	2,82E+09

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